

3.2mmx3.6mm FULL-COLOR SURFACE MOUNT LED LAMP



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APF3236SEKJ3ZGKQBKC

Hyper Red Green

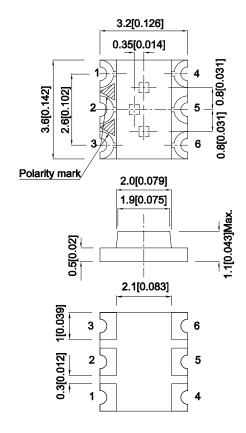
Features

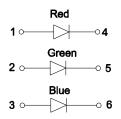
- 3.2mmx3.6mm SMD LED, 1.1mm thickness.
- Low power consumption.
- One red, one green and one blue chips in one package.
- Package: 1000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

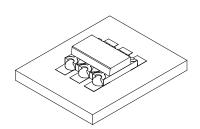
Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- The Blue source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions







SPEC NO: DSAO2079

APPROVED: Wynec

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.3B

CHECKED: Allen Liu

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APF3236SEKJ3ZGKQBKC	Hyper Red (AlGaInP)		200	350	150°
	Green (InGaN)	Water Clear	200	320	
	Blue (InGaN)		40	70	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	640 515 460		nm	Ir=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	625 525 465		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	20 35 25		nm	IF=20mA
С	Capacitance	Hyper Red Green Blue	27 45 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	2.2 3.3 3.3	2.8 4.1 4	V	IF=20mA
lR	Reverse Current	Hyper Red Green Blue		10 50 50	uA	VR=5V

Notes:

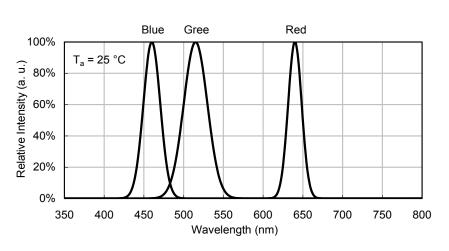
- Wavelength: +/-1nm.
 Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

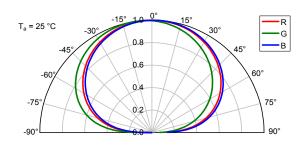
Parameter	Hyper Red	Green	Blue	Units		
Power dissipation	84	102.5	120	mW		
DC Forward Current	30	25	30	mA		
Peak Forward Current [1]	150	150	150	mA		
Electrostatic Discharge Threshold (HBM)	3000	450	250	V		
Reverse Voltage		V				
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

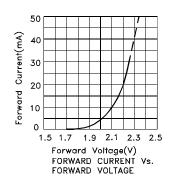
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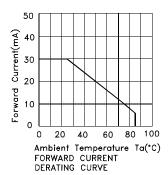


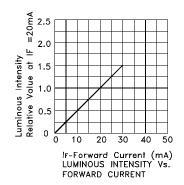
RGB Spatial Distribution

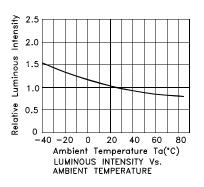


APF3236SEKJ3ZGKQBKC Hyper Red



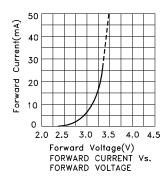


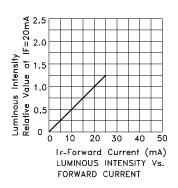


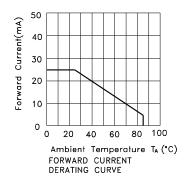


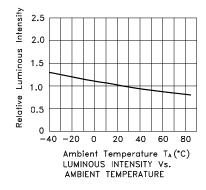
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Green

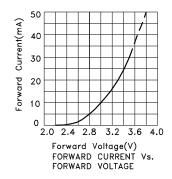


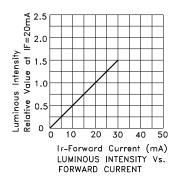


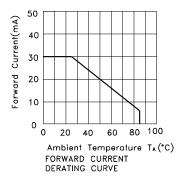


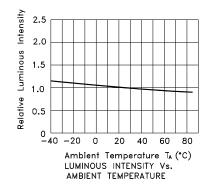


Blue







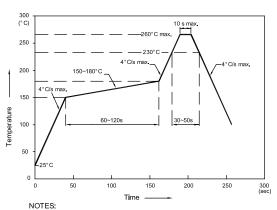


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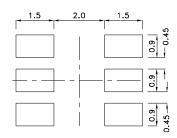
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

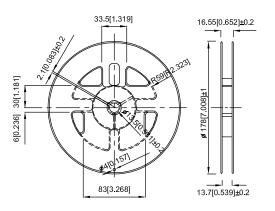


- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

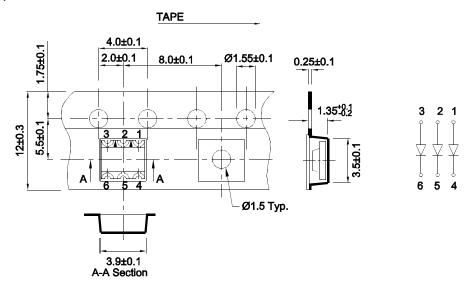
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



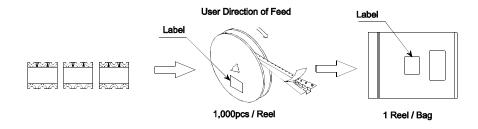
Tape Dimensions (Units: mm)

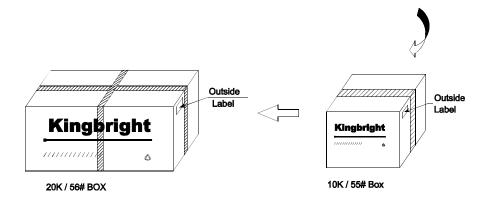


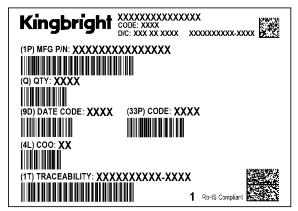
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PACKING & LABEL SPECIFICATIONS

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